

January 2015

FDMS86550ET60 N-Channel PowerTrench[®] MOSFET **60 V, 245 A, 1.65 m**Ω

Features

- Extended T_{.1} rating to 175°C
- Max $r_{DS(on)}$ = 1.65 m Ω at V_{GS} = 10 V, I_D = 32 A
- Max $r_{DS(on)}$ = 2.2 m Ω at V_{GS} = 8 V, I_D = 27 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

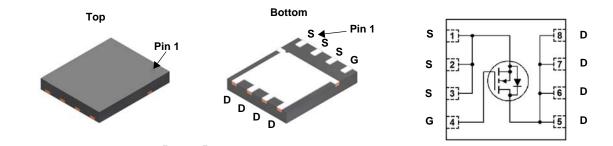


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Applications

- Primary DC-DC MOSFET
- Secondary Synchronous Rectifier
- Load Switch



Power 56

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			60	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T _C = 25 °C	(Note 5)	245		
	-Continuous	T _C = 100 °C	(Note 5)	173	٨	
	-Continuous	T _A = 25 °C	(Note 1a)	32	Α	
	-Pulsed	(Note 4)	1068			
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	937	mJ	
P _D	Power Dissipation	T _C = 25 °C		187	14/	
	Power Dissipation	T _A = 25 °C	(Note 1a)	3.3	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range -55			-55 to +175	°C	

Thermal Characteristics

FDMS86550ET60 Rev. C

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.8	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a)	45	C/VV

Package Marking and Ordering Information

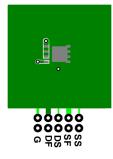
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86550ET	FDMS86550ET60	Power 56	13 "	12 mm	3000 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	60			V	
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		31		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48 V, V_{GS} = 0 V$			1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2.5	3.3	4.5	V	
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-12		mV/°C	
		V _{GS} = 10 V, I _D = 32 A		1.4	1.65		
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 8 V, I _D = 27 A		1.7	2.2	mΩ	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 32 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		2.2	2.6	-	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 32 A		96		S	
Dynamic	Characteristics						
C _{iss}	Input Capacitance			8235		pF	
C _{oss}	Output Capacitance	V _{DS} = 30 V, V _{GS} = 0 V, f = 1 MHz		2140		pF	
C _{rss}	Reverse Transfer Capacitance			70		pF	
R _g	Gate Resistance		0.1	0.9	2.7	Ω	
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time			43	69	ns	
t _r	Rise Time	V _{DD} = 30 V, I _D = 32 A,		27	43	ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		42	67	ns	
t _f	Fall Time			11	20	ns	
Q _g	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		110	154	nC	
Q _q	Total Gate Charge	$V_{GS} = 0 V \text{ to } 8 V V_{DD} = 30 V,$		90	126	nC	
Q _{gs}	Gate to Source Charge	I _D = 32 A		40		nC	
Q _{qd}	Gate to Drain "Miller" Charge			20		nC	
Drain-Sou	urce Diode Characteristics					1	
		$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.7	1.2		
	Source to Drain Diode Forward Voltage	00 / 0		0.7 0.8	1.2 1.3	V	
Drain-Sou V _{SD}				-		V	

Notes: 1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0CA} is determined by the user's board design.

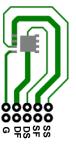


2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

4. Pulse Id please refers to Figure.11 SOA Curve for detail.

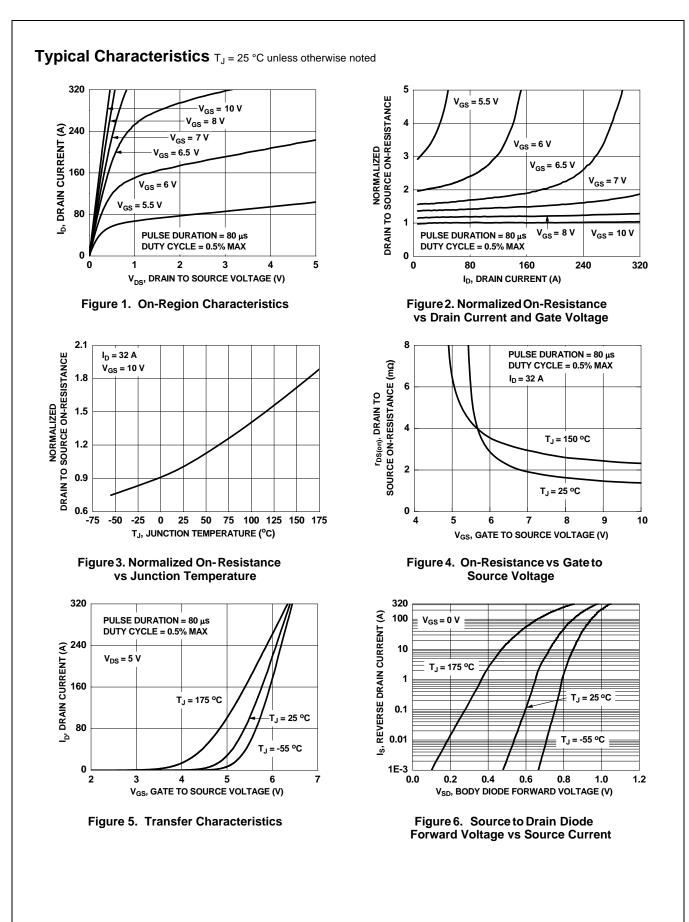
a. 45 °C/W when mounted on a 1 in $^2\,\text{pad}$ of 2 oz copper.

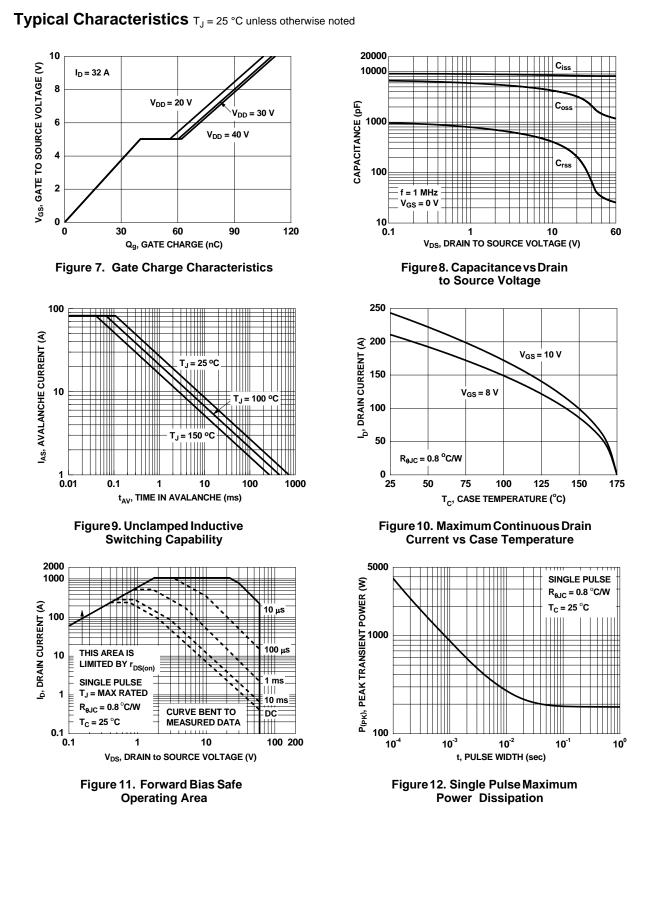
3. E_{AS} of 937 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 25 A, V_{DD} = 60 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 79 A.

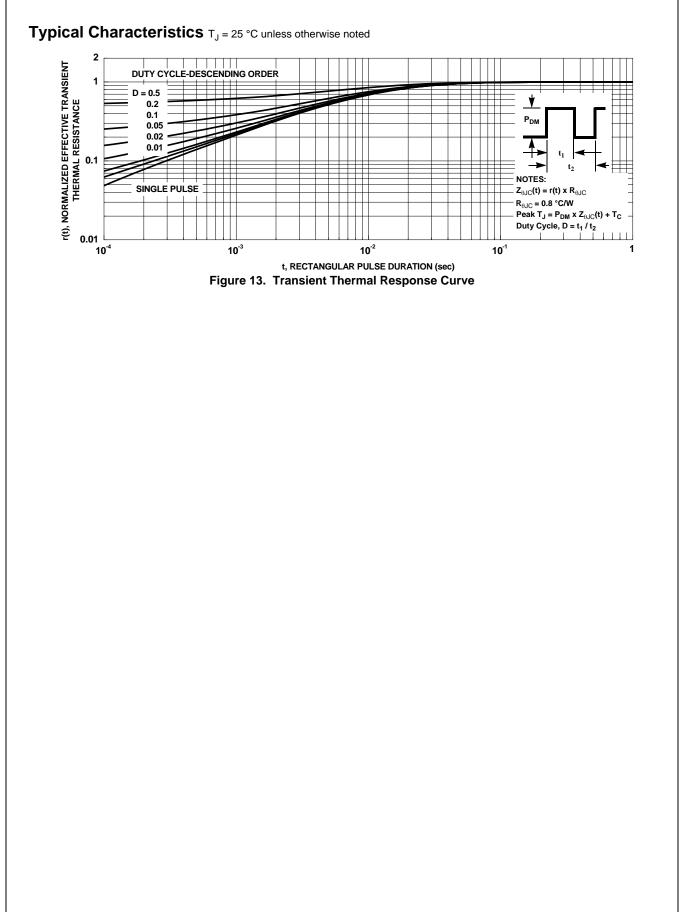


b. 115 °C/W when mounted on a minimum pad of 2 oz copper.

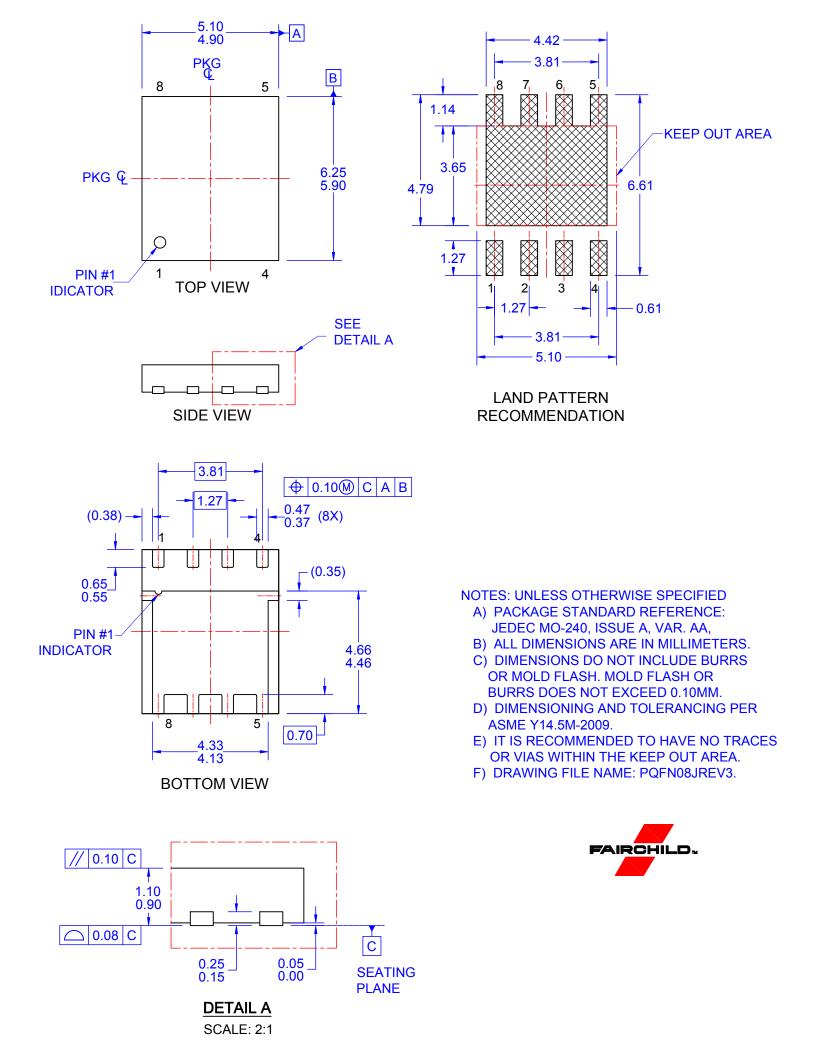
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.







FDMS86550ET60 N-Channel PowerTrench[®] MOSFET





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